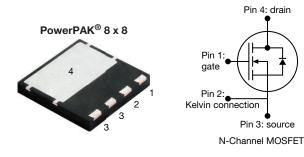
Vishay Siliconix

# **EF Series Power MOSFET With Fast Body Diode**



www.vishay.com

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.091					
Q <sub>g</sub> max. (nC)	50					
Q <sub>gs</sub> (nC)	16					
Q <sub>gd</sub> (nC)	8					
Configuration	Single					

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SIHH105N60EF-T1GE3

ABSOLUTE MAXIMUM RATINGS	$(T_C = 25 \ ^{\circ}C, \text{ unless otherwise})$	erwise noted)		
PARAMETER			LIMIT	UNIT
Drain-source voltage	V <sub>DS</sub>	600	V	
Gate-source voltage	V <sub>GS</sub>	± 30	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $\frac{T_{C} = 25}{T_{C} = 100}$	°C	26	
	$T_{\rm C} = 100$	°C	17	А
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	59		
Linear derating factor			1.38	W/°C
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	127	mJ
Maximum power dissipation	PD	174	W	
Operating junction and storage temperature ra	nge	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	°C dv/dt	100	V/ns	
Reverse diode dv/dt <sup>c</sup>	uv/ui	50	V/115	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.0 A
- c.  $I_{SD} \leq I_D, \, di/dt$  = 120 A/µs, starting  $T_J$  = 25  $^\circ C$



COMPLIANT

HALOGEN

FREE GREEN

(5-2008)



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	40	42	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	0.55	0.72	C/W		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•		•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	3.0	-	5.0	V
	1	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 V	-	-	± 1	uA
Zava anto valtaga duoin ovument		V <sub>DS</sub> =	= 480 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2	mA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 13 A	-	0.091	0.105	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 10 V, I <sub>D</sub> = 13 A	-	13	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	2099	-	-
Output capacitance	C <sub>oss</sub>	,	$V_{\rm DS} = 100  \rm V,$	-	87	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	-	5	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	65	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	408	-	
Total gate charge	Qg				33	50	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$		-	16	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	8	-	
Turn-on delay time	t <sub>d(on)</sub>			-	31	62	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 13 A,		-	62	93	1
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, $R_g$ = 9.1 $\Omega$	-	38	76	ns
Fall time	t <sub>f</sub>				28	56	1
Gate input resistance	Rg		f = 1 MHz		0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	26	
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode		-	-	59	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 13 A, V <sub>GS</sub> = 0 V		-	1.2	V
Reverse recovery time	t <sub>rr</sub>		T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 13 A,		126	252	ns
Reverse recovery charge	Q <sub>rr</sub>				0.6	1.2	μC
Reverse recovery current	I <sub>BBM</sub>	di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	9.4	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

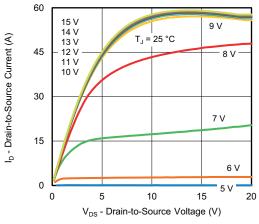


Fig. 1 - Typical Output Characteristics

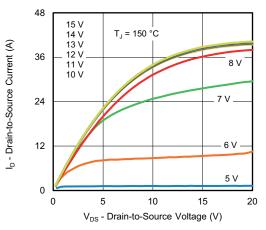


Fig. 2 - Typical Output Characteristics

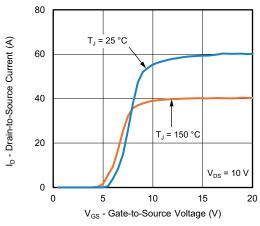


Fig. 3 - Typical Transfer Characteristics

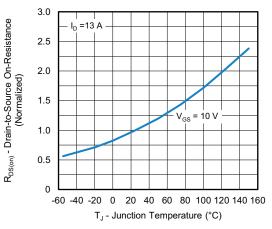


Fig. 4 - Normalized On-Resistance vs. Temperature

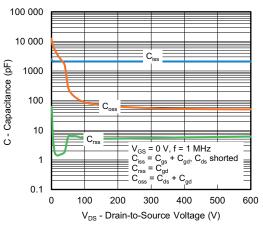
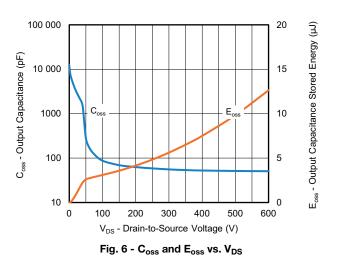


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S23-0654-Rev. B, 21-Aug-2023

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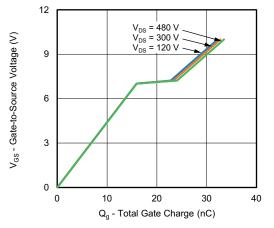


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

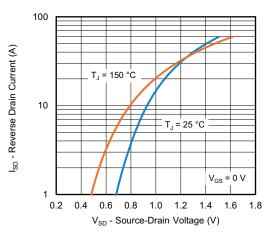


Fig. 8 - Typical Source-Drain Diode Forward Voltage

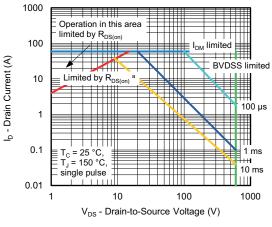


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

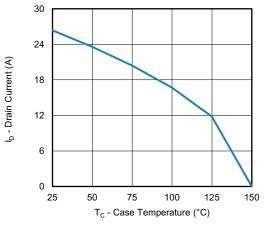


Fig. 10 - Maximum Drain Current vs. Case Temperature

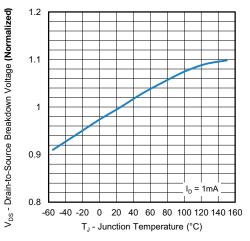
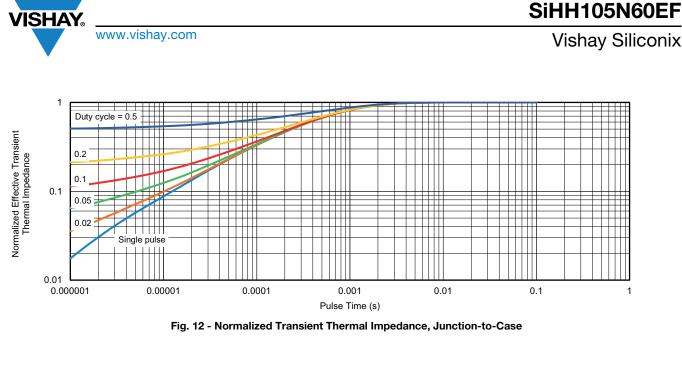


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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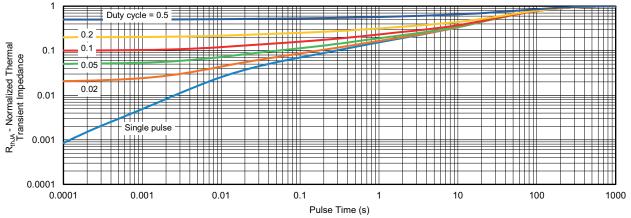


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

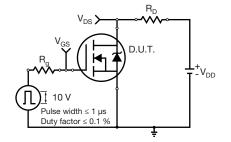


Fig. 14 - Switching Time Test Circuit

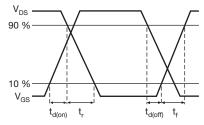


Fig. 15 - Switching Time Waveforms

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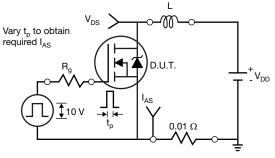


Fig. 16 - Unclamped Inductive Test Circuit

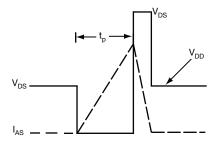


Fig. 17 - Unclamped Inductive Waveforms

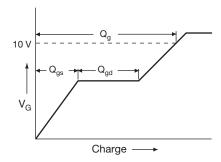


Fig. 18 - Basic Gate Charge Waveform

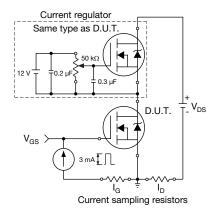


Fig. 19 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

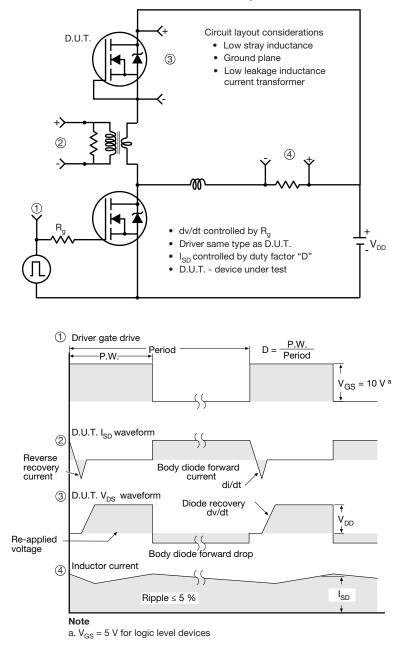


Fig. 20 - For N-Channel

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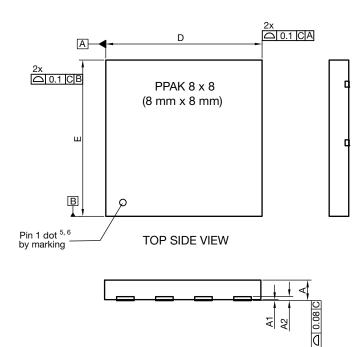
7

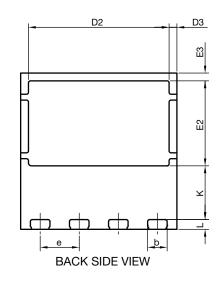
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM	MILLIMETERS		INCHES					
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2	020 ref.			0.008 ref.				
b	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3	0.40 BSC			0.016 BSC				
е	2.00 BSC		0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3		0.40 BSC			0.40 BSC 0.016 BSC			
К	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N <sup>(3)</sup>	8				8			

#### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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